

CENTER FOR MICROELECTRONICS      CONTRACT AMOUNT: \$ 244,080  
Gerald B. Stringfellow, University of Utah

The main focus is to develop new material for semiconductor devices, new technology for processing of these new materials into useful devices and circuits, new integrated circuit design tools for existing silicon circuits and for the new devices.

<u>Matching Funds:</u>	<u>In-Kind</u>	<u>Cash</u>
<u>Source</u>		
Department of Energy		\$ 735,552
DARPA		5,003,496
UNISYS		277,000
American Cyanamid		77,682
NASA		70,000
General Instrument		500,000
National Science Foundation		214,531
ONR		162,922
ATM		19,177
ONR/NRL		<u>451,008</u>
	<b>TOTAL</b>	<b>\$ 7,864,995</b>

Companies Associated Since Contract (6)

General Instrument  
 Advanced Technology Materials  
 Purdue Fredrick Co.  
 NSF  
 ONR/NRL  
 Bonneville Microelectronics\*

In-State Associations

UNISYS  
 Bonneville Microelectronics

Out-of-State Associations

General Instrument  
 Advanced Technology Materials  
 Purdue Fredrick Co.  
 National Science Foundation  
 American Cynamid  
 DARPA

Center for Microelectronics Contract #87-2893

<u>Payments:</u>	<u>Amount</u>	<u>Balance</u>
04 Dec 87	\$32,116	\$211,964
16 Feb 88	19,269	192,695

Total Payments: \$51,385